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Details

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Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	I ² C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	33
Program Memory Size	7KB (4K x 14)
Program Memory Type	FLASH
EEPROM Size	128 x 8
RAM Size	192 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	A/D 8x10b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lf874t-04i-pt

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1.0 DEVICE OVERVIEW

This document contains device specific information. Additional information may be found in the PIC[®] MCU Mid-Range Reference Manual (DS33023), which may be obtained from your local Microchip Sales Representative or downloaded from the Microchip website. The Reference Manual should be considered a complementary document to this data sheet, and is highly recommended reading for a better understanding of the device architecture and operation of the peripheral modules. There are four devices (PIC16F873, PIC16F874, PIC16F876 and PIC16F877) covered by this data sheet. The PIC16F876/873 devices come in 28-pin packages and the PIC16F877/874 devices come in 40-pin packages. The Parallel Slave Port is not implemented on the 28-pin devices.

The following device block diagrams are sorted by pin number; 28-pin for Figure 1-1 and 40-pin for Figure 1-2. The 28-pin and 40-pin pinouts are listed in Table 1-1 and Table 1-2, respectively.





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TRISE REGISTER (ADDRESS 89h) R/W-1 R-0 R-0 R/W-0 R/W-0 U-0 R/W-1 R/W-1 IBF OBF **IBOV PSPMODE** Bit2 Bit1 Bit0 bit 7 bit 0 Parallel Slave Port Status/Control Bits: bit 7 IBF: Input Buffer Full Status bit 1 = A word has been received and is waiting to be read by the CPU 0 = No word has been received bit 6 **OBF**: Output Buffer Full Status bit 1 = The output buffer still holds a previously written word 0 = The output buffer has been read bit 5 **IBOV**: Input Buffer Overflow Detect bit (in Microprocessor mode) 1 = A write occurred when a previously input word has not been read (must be cleared in software) 0 = No overflow occurred bit 4 PSPMODE: Parallel Slave Port Mode Select bit 1 = PORTD functions in Parallel Slave Port mode 0 = PORTD functions in general purpose I/O mode Unimplemented: Read as '0' bit 3 **PORTE Data Direction Bits:** Bit2: Direction Control bit for pin RE2/CS/AN7 bit 2 1 = Input0 = OutputBit1: Direction Control bit for pin RE1/WR/AN6 bit 1 1 = Input 0 = Output Bit0: Direction Control bit for pin RE0/RD/AN5 bit 0 1 = Input 0 = Output Legend:

W = Writable bit

'1' = Bit is set

U = Unimplemented bit, read as '0'

x = Bit is unknown

'0' = Bit is cleared

R = Readable bit

- n = Value at POR

REGISTER 3-1:

5.2 Using Timer0 with an External Clock

When no prescaler is used, the external clock input is the same as the prescaler output. The synchronization of TOCKI with the internal phase clocks is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks. Therefore, it is necessary for T0CKI to be high for at least 2Tosc (and a small RC delay of 20 ns) and low for at least 2Tosc (and a small RC delay of 20 ns). Refer to the electrical specification of the desired device.

5.3 Prescaler

There is only one prescaler available, which is mutually exclusively shared between the Timer0 module and the Watchdog Timer. A prescaler assignment for the

REGISTER 5-1: OPTION REG REGISTER

DANA

Timer0 module means that there is no prescaler for the Watchdog Timer, and vice-versa. This prescaler is not readable or writable (see Figure 5-1).

The PSA and PS2:PS0 bits (OPTION_REG<3:0>) determine the prescaler assignment and prescale ratio.

When assigned to the Timer0 module, all instructions writing to the TMR0 register (e.g. CLRF1, MOVWF1, BSF 1, x....etc.) will clear the prescaler. When assigned to WDT, a CLRWDT instruction will clear the prescaler along with the Watchdog Timer. The prescaler is not readable or writable.

Note: Writing to TMR0, when the prescaler is assigned to Timer0, will clear the prescaler count, but will not change the prescaler assignment.

	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1				
	RBPU	INTEDG	T0CS	TOSE	PSA	PS2	PS1	PS0				
	bit 7							bit 0				
bit 7	RBPU											
bit 6	INTEDG											
bit 5	1 = Transit	R0 Clock Sou tion on T0CK al instruction o	l pin									
bit 4	1 = Increm	R0 Source Ed nent on high-t nent on low-to	o-low trans	sition on TOC	•							
bit 3	PSA : Prescaler Assignment bit 1 = Prescaler is assigned to the WDT 0 = Prescaler is assigned to the Timer0 module											
bit 2-0	PS2:PS0: Prescaler Rate Select bits											
	Bit Value	TMR0 Rate	WDT Rat	e								
	000 001 010 011 100 101 110 111	1:2 1:4 1:8 1:16 1:32 1:64 1:128 1:256	1 : 1 1 : 2 1 : 4 1 : 8 1 : 16 1 : 32 1 : 64 1 : 128	-								
	Legend:											
	R = Reada	able bit	VV = V	Vritable bit	U = Unimple	emented b	it, read as '()'				
	- n = Value	e at POR	'1' = E	Bit is set	'0' = Bit is c	leared	x = Bit is ur	nknown				
ily Reference	ce Manual (DS33023) m	ust be exe	cuted when	ience shown in changing the pr /DT is disabled.	escaler as	MCU Mid-Ra signment fr	ange Fam- om Timer0				

Note:

6.4 Timer1 Operation in Asynchronous Counter Mode

If control bit $\overline{T1SYNC}$ (T1CON<2>) is set, the external clock input is not synchronized. The timer continues to increment asynchronous to the internal phase clocks. The timer will continue to run during SLEEP and can generate an interrupt-on-overflow, which will wake-up the processor. However, special precautions in software are needed to read/write the timer (Section 6.4.1).

In Asynchronous Counter mode, Timer1 cannot be used as a time-base for capture or compare operations.

6.4.1 READING AND WRITING TIMER1 IN ASYNCHRONOUS COUNTER MODE

Reading TMR1H or TMR1L while the timer is running from an external asynchronous clock, will guarantee a valid read (taken care of in hardware). However, the user should keep in mind that reading the 16-bit timer in two 8-bit values itself, poses certain problems, since the timer may overflow between the reads.

For writes, it is recommended that the user simply stop the timer and write the desired values. A write contention may occur by writing to the timer registers, while the register is incrementing. This may produce an unpredictable value in the timer register.

Reading the 16-bit value requires some care. Examples 12-2 and 12-3 in the PIC[®] MCU Mid-Range Family Reference Manual (DS33023) show how to read and write Timer1 when it is running in Asynchronous mode.

6.5 Timer1 Oscillator

A crystal oscillator circuit is built-in between pins T1OSI (input) and T1OSO (amplifier output). It is enabled by setting control bit T1OSCEN (T1CON<3>). The oscillator is a low power oscillator, rated up to 200 kHz. It will continue to run during SLEEP. It is primarily intended for use with a 32 kHz crystal. Table 6-1 shows the capacitor selection for the Timer1 oscillator.

The Timer1 oscillator is identical to the LP oscillator. The user must provide a software time delay to ensure proper oscillator start-up.

TABLE 6-1:CAPACITOR SELECTION FOR
THE TIMER1 OSCILLATOR

Osc Type	Freq.	C1	C2							
LP	32 kHz	33 pF								
	100 kHz	15 pF	15 pF							
	200 kHz	15 pF	15 pF							
These values are for design guidance only.										
Crystals Tested:										
32.768 kHz Epson C-001R32.768K-A ± 20 P										
100 kHz	Epson C-2 100.00 KC-P ± 20 PPN									
200 kHz	STD XTL 200.000 kHz ± 20 PPI									
 Note 1: Higher capacitance increases the stability of oscillator, but also increases the start-up time. 2: Since each resonator/crystal has its own characteristics, the user should consult the resonator/crystal manufacturer for appropriate values of external components. 										

6.6 Resetting Timer1 using a CCP Trigger Output

If the CCP1 or CCP2 module is configured in Compare mode to generate a "special event trigger" (CCP1M3:CCP1M0 = 1011), this signal will reset Timer1.

Note:	The special event triggers from the CCP1
	and CCP2 modules will not set interrupt
	flag bit TMR1IF (PIR1<0>).

Timer1 must be configured for either Timer or Synchronized Counter mode to take advantage of this feature. If Timer1 is running in Asynchronous Counter mode, this RESET operation may not work.

In the event that a write to Timer1 coincides with a special event trigger from CCP1 or CCP2, the write will take precedence.

In this mode of operation, the CCPRxH:CCPRxL register pair effectively becomes the period register for Timer1.

9.2.1 SLAVE MODE

In Slave mode, the SCL and SDA pins must be configured as inputs. The MSSP module will override the input state with the output data, when required (slavetransmitter).

When an address is matched, or the data transfer after an address match is received, the hardware automatically will generate the Acknowledge (\overline{ACK}) pulse, and then load the SSPBUF register with the received value currently in the SSPSR register.

There are certain conditions that will cause the MSSP module not to give this ACK pulse. These are if either (or both):

- a) The buffer full bit BF (SSPSTAT<0>) was set before the transfer was received.
- b) The overflow bit SSPOV (SSPCON<6>) was set before the transfer was received.

If the BF bit is set, the SSPSR register value is not loaded into the SSPBUF, but bit SSPIF and SSPOV are set. Table 9-2 shows what happens when a data transfer byte is received, given the status of bits BF and SSPOV. The shaded cells show the condition where user software did not properly clear the overflow condition. Flag bit BF is cleared by reading the SSPBUF register, while bit SSPOV is cleared through software.

The SCL clock input must have a minimum high and low time for proper operation. The high and low times of the I^2C specification, as well as the requirement of the MSSP module, is shown in timing parameter #100 and parameter #101 of the electrical specifications.

9.2.1.1 Addressing

Once the MSSP module has been enabled, it waits for a START condition to occur. Following the START condition, the 8-bits are shifted into the SSPSR register. All incoming bits are sampled with the rising edge of the clock (SCL) line. The value of register SSPSR<7:1> is compared to the value of the SSPADD register. The address is compared on the falling edge of the eighth clock (SCL) pulse. If the addresses match, and the BF and SSPOV bits are clear, the following events occur:

- The SSPSR register value is loaded into the SSPBUF register on the falling edge of the 8th SCL pulse.
- b) The buffer full bit, BF, is set on the falling edge of the 8th SCL pulse.
- c) An ACK pulse is generated.
- d) SSP interrupt flag bit, SSPIF (PIR1<3>), is set (interrupt is generated if enabled) on the falling edge of the 9th SCL pulse.

In 10-bit address mode, two address bytes need to be received by the slave. The five Most Significant bits (MSbs) of the first address byte specify if this is a 10-bit address. Bit R/W (SSPSTAT<2>) must specify a write so the slave device will receive the second address byte.

For a 10-bit address, the first byte would equal '1111 0 A9 A8 0', where A9 and A8 are the two MSbs of the address. The sequence of events for a 10-bit address is as follows, with steps 7-9 for slave-transmitter:

- 1. Receive first (high) byte of Address (bits SSPIF, BF and UA (SSPSTAT<1>) are set).
- 2. Update the SSPADD register with the second (low) byte of Address (clears bit UA and releases the SCL line).
- 3. Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.
- 4. Receive second (low) byte of Address (bits SSPIF, BF and UA are set).
- 5. Update the SSPADD register with the first (high) byte of Address. This will clear bit UA and release the SCL line.
- 6. Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.
- 7. Receive Repeated Start condition.
- 8. Receive first (high) byte of Address (bits SSPIF and BF are set).
- 9. Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.

Note:	Following the Repeated START condition (step 7) in 10-bit mode, the user only needs to match the first 7-bit address. The
	user does not update the SSPADD for the second half of the address.

9.2.1.2 Slave Reception

When the R/\overline{W} bit of the address byte is clear and an address match occurs, the R/\overline{W} bit of the SSPSTAT register is cleared. The received address is loaded into the SSPBUF register.

When the address byte overflow condition exists, then no Acknowledge (ACK) pulse is given. An overflow condition is defined as either bit BF (SSPSTAT<0>) is set, or bit SSPOV (SSPCON<6>) is set. This is an error condition due to user firmware.

An SSP interrupt is generated for each data transfer byte. Flag bit SSPIF (PIR1<3>) must be cleared in software. The SSPSTAT register is used to determine the status of the received byte.

Note: The SSPBUF will be loaded if the SSPOV bit is set and the BF flag is cleared. If a read of the SSPBUF was performed, but the user did not clear the state of the SSPOV bit before the next receive occurred, the ACK is not sent and the SSPBUF is updated.

TABLE 10-3: BAUD RATES FOR ASYNCHRONOUS MODE (BRGH = 0)

BAUD	F	osc = 20 M	IHz	F	osc = 16 N	IHz	Fosc = 10 MHz			
RATE (K)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	
0.3	-	-	-	-	-	-	-	-	-	
1.2	1.221	1.75	255	1.202	0.17	207	1.202	0.17	129	
2.4	2.404	0.17	129	2.404	0.17	103	2.404	0.17	64	
9.6	9.766	1.73	31	9.615	0.16	25	9.766	1.73	15	
19.2	19.531	1.72	15	19.231	0.16	12	19.531	1.72	7	
28.8	31.250	8.51	9	27.778	3.55	8	31.250	8.51	4	
33.6	34.722	3.34	8	35.714	6.29	6	31.250	6.99	4	
57.6	62.500	8.51	4	62.500	8.51	3	52.083	9.58	2	
HIGH	1.221	-	255	0.977	-	255	0.610	-	255	
LOW	312.500	-	0	250.000	-	0	156.250	-	0	

DAUD		Fosc = 4 M	Hz	Fo	sc = 3.6864	MHz
BAUD RATE (K)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)
0.3	0.300	0	207	0.3	0	191
1.2	1.202	0.17	51	1.2	0	47
2.4	2.404	0.17	25	2.4	0	23
9.6	8.929	6.99	6	9.6	0	5
19.2	20.833	8.51	2	19.2	0	2
28.8	31.250	8.51	1	28.8	0	1
33.6	-	-	-	-	-	-
57.6	62.500	8.51	0	57.6	0	0
HIGH	0.244	-	255	0.225	-	255
LOW	62.500	-	0	57.6	-	0

TABLE 10-4: BAUD RATES FOR ASYNCHRONOUS MODE (BRGH = 1)

BAUD	F	osc = 20 M	Hz	F	osc = 16 M	Hz	Fosc = 10 MHz			
RATE (K)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)	
0.3	-	-	-	-	-	-	-	-	-	
1.2	-	-	-	-	-	-	-	-	-	
2.4	-	-	-	-	-	-	2.441	1.71	255	
9.6	9.615	0.16	129	9.615	0.16	103	9.615	0.16	64	
19.2	19.231	0.16	64	19.231	0.16	51	19.531	1.72	31	
28.8	29.070	0.94	42	29.412	2.13	33	28.409	1.36	21	
33.6	33.784	0.55	36	33.333	0.79	29	32.895	2.10	18	
57.6	59.524	3.34	20	58.824	2.13	16	56.818	1.36	10	
HIGH	4.883	-	255	3.906	-	255	2.441	-	255	
LOW	1250.000	-	0	1000.000		0	625.000	-	0	

BAUD	F	osc = 4 MH	łz	Fosc = 3.6864 MHz				
RATE (K)	KBAUD	% ERROR	SPBRG value (decimal)	KBAUD	% ERROR	SPBRG value (decimal)		
0.3	-	-	-	-	-	-		
1.2	1.202	0.17	207	1.2	0	191		
2.4	2.404	0.17	103	2.4	0	95		
9.6	9.615	0.16	25	9.6	0	23		
19.2	19.231	0.16	12	19.2	0	11		
28.8	27.798	3.55	8	28.8	0	7		
33.6	35.714	6.29	6	32.9	2.04	6		
57.6	62.500	8.51	3	57.6	0	3		
HIGH	0.977	-	255	0.9	-	255		
LOW	250.000	-	0	230.4	-	0		



FIGURE 10-8: ASYNCHRONOUS RECEPTION WITH ADDRESS BYTE FIRST



TABLE 10-7: REGISTERS ASSOCIATED WITH ASYNCHRONOUS RECEPTION

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other RESETS
0Bh, 8Bh, 10Bh,18Bh	INTCON	GIE	PEIE	TOIE	INTE	RBIE	TOIF	INTF	R0IF	x000 0000x	0000 000u
0Ch	PIR1	PSPIF ⁽¹⁾	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
18h	RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 000x	0000 000x
1Ah	RCREG	USART Re	ceive Re	gister						0000 0000	0000 0000
8Ch	PIE1	PSPIE ⁽¹⁾	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
98h	TXSTA	CSRC	TX9	TXEN	SYNC	—	BRGH	TRMT	TX9D	0000 -010	0000 -010
99h	SPBRG	Baud Rate	Generato		0000 0000	0000 0000					

Legend: x = unknown, - = unimplemented locations read as '0'. Shaded cells are not used for asynchronous reception. Note 1: Bits PSPIE and PSPIF are reserved on PIC16F873/876 devices; always maintain these bits clear.

REGISTER 11-2: ADCON1 REGISTER (ADDRESS 9Fh)

U-0	U-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
ADFM	—	—	—	PCFG3	PCFG2	PCFG1	PCFG0
bit 7							bit 0

bit 7 ADFM: A/D Result Format Select bit

1 = Right justified. 6 Most Significant bits of ADRESH are read as '0'.

0 = Left justified. 6 Least Significant bits of ADRESL are read as '0'.

bit 6-4 Unimplemented: Read as '0'

bit 3-0 **PCFG3:PCFG0**: A/D Port Configuration Control bits:

PCFG3: PCFG0	AN7 ⁽¹⁾ RE2	AN6 ⁽¹⁾ RE1	AN5 ⁽¹⁾ RE0	AN4 RA5	AN3 RA3	AN2 RA2	AN1 RA1	AN0 RA0	VREF+	VREF-	CHAN/ Refs ⁽²⁾
0000	Α	Α	А	А	Α	Α	Α	Α	Vdd	Vss	8/0
0001	А	А	А	А	VREF+	А	Α	Α	RA3	Vss	7/1
0010	D	D	D	А	Α	Α	Α	Α	Vdd	Vss	5/0
0011	D	D	D	А	VREF+	А	Α	Α	RA3	Vss	4/1
0100	D	D	D	D	Α	D	Α	Α	Vdd	Vss	3/0
0101	D	D	D	D	VREF+	D	Α	А	RA3	Vss	2/1
011x	D	D	D	D	D	D	D	D	Vdd	Vss	0/0
1000	А	А	А	А	VREF+	VREF-	Α	Α	RA3	RA2	6/2
1001	D	D	А	А	Α	Α	Α	Α	Vdd	Vss	6/0
1010	D	D	А	А	VREF+	Α	А	А	RA3	Vss	5/1
1011	D	D	А	А	VREF+	VREF-	Α	Α	RA3	RA2	4/2
1100	D	D	D	А	VREF+	VREF-	Α	Α	RA3	RA2	3/2
1101	D	D	D	D	VREF+	VREF-	А	А	RA3	RA2	2/2
1110	D	D	D	D	D	D	D	Α	Vdd	Vss	1/0
1111	D	D	D	D	VREF+	Vref-	D	А	RA3	RA2	1/2

A = Analog input D = Digital I/O

Note 1: These channels are not available on PIC16F873/876 devices.

2: This column indicates the number of analog channels available as A/D inputs and the number of analog channels used as voltage reference inputs.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented	bit, read as '0'
- n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

The ADRESH:ADRESL registers contain the 10-bit result of the A/D conversion. When the A/D conversion is complete, the result is loaded into this A/D result register pair, the GO/DONE bit (ADCON0<2>) is cleared and the A/D interrupt flag bit ADIF is set. The block diagram of the A/D module is shown in Figure 11-1.

After the A/D module has been configured as desired, the selected channel must be acquired before the conversion is started. The analog input channels must have their corresponding TRIS bits selected as inputs. To determine sample time, see Section 11.1. After this acquisition time has elapsed, the A/D conversion can be started.

						,					
Register	Devices				Power-on Reset, Brown-out Reset	MCLR Resets, WDT Reset	Wake-up via WDT or Interrupt				
PIE2	873	874	876	877	-r-0 00	-r-0 00	-r-u uu				
PCON	873	874	876	877	dd	uu	uu				
PR2	873	874	876	877	1111 1111	1111 1111	1111 1111				
SSPADD	873	874	876	877	0000 0000	0000 0000	uuuu uuuu				
SSPSTAT	873	874	876	877	00 0000	00 0000	uu uuuu				
TXSTA	873	874	876	877	0000 -010	0000 -010	uuuu -uuu				
SPBRG	873	874	876	877	0000 0000	0000 0000	uuuu uuuu				
ADRESL	873	874	876	877	XXXX XXXX	սսսս սսսս	uuuu uuuu				
ADCON1	873	874	876	877	0 0000	0 0000	u uuuu				
EEDATA	873	874	876	877	0 0000	0 0000	u uuuu				
EEADR	873	874	876	877	XXXX XXXX	սսսս սսսս	uuuu uuuu				
EEDATH	873	874	876	877	XXXX XXXX	սսսս սսսս	uuuu uuuu				
EEADRH	873	874	876	877	XXXX XXXX	սսսս սսսս	uuuu uuuu				
EECON1	873	874	876	877	x x000	u u000	u uuuu				
EECON2	873	874	876	877							

TABLE 12-6: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition, r = reserved, maintain clear

Note 1: One or more bits in INTCON, PIR1 and/or PIR2 will be affected (to cause wake-up).

2: When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).

3: See Table 12-5 for RESET value for specific condition.

FIGURE 12-5: TIME-OUT SEQUENCE ON POWER-UP (MCLR TIED TO VDD)



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	_	>	× × ×	~			>							>	>					
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			>	>			>	>				`								
			>	`	>		>	>												
MBLAB® C17 C Compiler	PLAB® C17 C Compiler	PLAB [®] C18 C Compiler	PASM TM Assembler/ PLINK TM Object Linker	MPLAB [®] ICE In-Circuit Emulator	ICEPIC TM In-Circuit Emulator	PLAB®ICD In-Circuit ebugger	PICSTART® Plus Entry Level Development Programmer	PRO MATE® II Universal Device Programmer	PICDEM™ 1 Demonstration Board	PICDEM™ 2 Demonstration Board	PICDEM™ 3 Demonstration Board	PICDEM TM 14A Demonstration Board	PICDEM™ 17 Demonstration Board	EELoo [®] Evaluation Kit	εεLoα [®] Transponder Kit	iicrolD™ Programmer's Kit	25 kHz microlD™ eveloper's Kit	125 kHz Anticollision microlD™ Developer's Kit	13.56 MHz Anticollision microlD™ Developer's Kit	MCP2510 CAN Developer's Kit
				MPLAB® C17 C Compile MPLAB® C18 C Compile MPASM™ Assembler/ MPLINK™ Object Linker																

TABLE 14-1:	DEVELOPMENT TOOLS FROM MICROCHIP
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FIGURE 15-2: PIC16LF87X-04 VOLTAGE-FREQUENCY GRAPH (COMMERCIAL AND INDUSTRIAL TEMPERATURE RANGES ONLY)





TABLE 15-1: EXTERNAL CLOCK TIMING REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Тур†	Max	Units	Conditions
	Fosc	External CLKIN Frequency	DC		4	MHz	XT and RC osc mode
		(Note 1)	DC	_	4	MHz	HS osc mode (-04)
			DC	_	10	MHz	HS osc mode (-10)
			DC	_	20	MHz	HS osc mode (-20)
			DC	—	200	kHz	LP osc mode
		Oscillator Frequency	DC		4	MHz	RC osc mode
		(Note 1)	0.1	—	4	MHz	XT osc mode
			4	—	10	MHz	HS osc mode (-10)
			4	_	20	MHz	HS osc mode (-20)
			5		200	kHz	LP osc mode
1	Tosc	External CLKIN Period	250		_	ns	XT and RC osc mode
		(Note 1)	250	_	—	ns	HS osc mode (-04)
			100	_	—	ns	HS osc mode (-10)
			50	—	—	ns	HS osc mode (-20)
			5	—	—	μS	LP osc mode
		Oscillator Period	250	_	—	ns	RC osc mode
		(Note 1)	250	—	10,000	ns	XT osc mode
			250	—	—	ns	HS osc mode (-04)
			100	_	250	ns	HS osc mode (-10)
			50	_	250	ns	HS osc mode (-20)
			5	—	—	μs	LP osc mode
2	Тсү	Instruction Cycle Time (Note 1)	200	TCY	DC	ns	Tcy = 4/Fosc
3	TosL,	External Clock in (OSC1) High or	100		—	ns	XT oscillator
	TosH	Low Time	2.5	—	—	μS	LP oscillator
			15	—	—	ns	HS oscillator
4	TosR,	External Clock in (OSC1) Rise or			25	ns	XT oscillator
	TosF	Fall Time	—	—	50	ns	LP oscillator
			—	—	15	ns	HS oscillator

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Instruction cycle period (TcY) equals four times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions, with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKIN pin. When an external clock input is used, the "max." cycle time limit is "DC" (no clock) for all devices.



FIGURE 15-8: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING

FIGURE 15-9: BROWN-OUT RESET TIMING



TABLE 15-3:RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER,
AND BROWN-OUT RESET REQUIREMENTS

Parameter No.	Symbol	Characteristic	Min	Тур†	Max	Units	Conditions
30	TmcL	MCLR Pulse Width (low)	2	-	_	μs	VDD = 5V, -40°C to +85°C
31*	Twdt	Watchdog Timer Time-out Period (No Prescaler)	7	18	33	ms	VDD = 5V, -40°C to +85°C
32	Tost	Oscillation Start-up Timer Period	_	1024 Tosc		—	Tosc = OSC1 period
33*	Tpwrt	Power-up Timer Period	28	72	132	ms	VDD = 5V, -40°C to +85°C
34	Tıoz	I/O Hi-impedance from MCLR Low or Watchdog Timer Reset	—	—	2.1	μS	
35	TBOR	Brown-out Reset pulse width	100	_	_	μS	$VDD \le VBOR (D005)$

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.











TABLE 15-13: A/D CONVERSION REQUIREMENTS

Param No.	Sym	Chara	cteristic	Min	Тур†	Max	Units	Conditions
130	TAD	A/D clock period	Standard(F)	1.6	_	_	μS	Tosc based, VREF \geq 3.0V
			Extended(LF)	3.0	—	_	μS	Tosc based, VREF \geq 2.0V
			Standard(F)	2.0	4.0	6.0	μS	A/D RC mode
			Extended(LF)	3.0	6.0	9.0	μS	A/D RC mode
131	TCNV	Conversion time (no (Note 1)		—	12	Tad		
132	TACQ	Acquisition time		(Note 2)	40	_	μS	
				10*	_	_	μS	The minimum time is the amplifier settling time. This may be used if the "new" input voltage has not changed by more than 1 LSb (i.e., 20.0 mV @ 5.12V) from the last sampled voltage (as stated on CHOLD).
134	TGO	Q4 to A/D clock star	t	_	Tosc/2 §	_	_	If the A/D clock source is selected as RC, a time of TCY is added before the A/D clock starts. This allows the SLEEP instruction to be executed.

These parameters are characterized but not tested.

Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are t not tested.

This specification ensured by design. §

Note 1: ADRES register may be read on the following TCY cycle.

2: See Section 11.1 for minimum conditions.

44-Lead Plastic Leaded Chip Carrier (L) – Square (PLCC)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



		INCHES*		N	MILLIMETERS				
Dimension	n Limits	MIN	NOM	MAX	MIN	NOM	MAX		
Number of Pins	n		44			44			
Pitch	р		.050			1.27			
Pins per Side	n1		11			11			
Overall Height	А	.165	.173	.180	4.19	4.39	4.57		
Molded Package Thickness	A2	.145	.153	.160	3.68	3.87	4.06		
Standoff §	A1	.020	.028	.035	0.51	0.71	0.89		
Side 1 Chamfer Height	A3	.024	.029	.034	0.61	0.74	0.86		
Corner Chamfer 1	CH1	.040	.045	.050	1.02	1.14	1.27		
Corner Chamfer (others)	CH2	.000	.005	.010	0.00	0.13	0.25		
Overall Width	Е	.685	.690	.695	17.40	17.53	17.65		
Overall Length	D	.685	.690	.695	17.40	17.53	17.65		
Molded Package Width	E1	.650	.653	.656	16.51	16.59	16.66		
Molded Package Length	D1	.650	.653	.656	16.51	16.59	16.66		
Footprint Width	E2	.590	.620	.630	14.99	15.75	16.00		
Footprint Length	D2	.590	.620	.630	14.99	15.75	16.00		
Lead Thickness	С	.008	.011	.013	0.20	0.27	0.33		
Upper Lead Width	B1	.026	.029	.032	0.66	0.74	0.81		
Lower Lead Width	В	.013	.020	.021	0.33	0.51	0.53		
Mold Draft Angle Top	α	0	5	10	0	5	10		
Mold Draft Angle Bottom	β	0	5	10	0	5	10		

* Controlling Parameter § Significant Characteristic

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side. JEDEC Equivalent: MO-047

Drawing No. C04-048

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